

November 2013

## FQP2N80

# N-Channel QFET $^{\circledR}$ MOSFET 800 V, 2.4 A, 6.3 $\Omega$

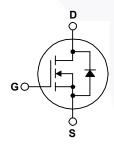
## **Description**

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

## **Features**

- 2.4 A, 800 V,  $R_{DS(on)}$  = 6.3  $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_D$  = 1.2 A
- Low Gate Charge (Typ. 12 nC)
- Low Crss (Typ. 5.5 pF)
- · 100% Avalanche Tested





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQP2N80	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		800	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C	)	2.4	Α
	- Continuous (T <sub>C</sub> = 100°C	C)	1.52	Α
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	9.6	Α
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		180	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	2.4	A
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	8.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)		85	W
	- Derate above 25°C	0.68	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering 1/8" from Case for 5 seconds	300	°C	

## **Thermal Characteristics**

Symbol	Parameter	FQP2N80	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.47	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

## **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP2N80	FQP2N80	TO-220	Tube	N/A	N/A	50 units

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				a 1 a			

T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Uni
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	800			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°	С	0.9		V/°C
I <sub>DSS</sub>	Zees Onto Valta as Dusin Ocursus	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V			10	μΑ
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 640 V, T <sub>C</sub> = 125°C			100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.2 A		4.9	6.3	Ω
9 <sub>FS</sub>	Forward Transconductance V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.2 A			2.65		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		45 5.5	60 7.0	pF pF
				5.5	7.0	рг
	ing Characteristics			40	0.5	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 2.4 \text{ A},$		12	35	ns
t <sub>r</sub>	Turn-On Rise Time	$R_G = 25 \Omega$		30	70	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	(Note	4)	25	60	ns
t <sub>f</sub>	Turn-Off Fall Time	,		28 12	65	ns
Q <sub>g</sub>	Total Gate Charge Gate-Source Charge	$V_{DS} = 640 \text{ V}, I_{D} = 2.4 \text{ A},$	/- //	2.6	15	nC nC
Q <sub>gs</sub> Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> = 10 V (Note		6.0		nC
⊶gd	Gale-Diam Charge	(1701)		0.0		TIC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				2.4	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode F	orward Current			9.6	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.4 \text{ A}$			1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 2.4 \text{ A},$		480		ns
^		11 / 11 / 400 4/				

## $Q_{rr}$

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature. 2. L = 59 mH, I $_{AS}$  = 2.4 A, V $_{DD}$  = 50 V, R $_{G}$  = 25  $\Omega$ , starting T $_{J}$  = 25°C. 3. I $_{SD}$  ≤ 2.4 A, di/dt ≤ 200 A/ $\mu$ s, V $_{DD}$  ≤ BV $_{DSS}$ , starting T $_{J}$  = 25°C. 4. Essentially independent of operating temperature.

Reverse Recovery Charge

μС

2.0

 $dI_F / dt = 100 A/\mu s$ 

## **Typical Characteristics**

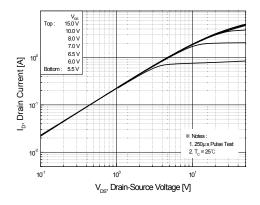


Figure 1. On-Region Characteristics

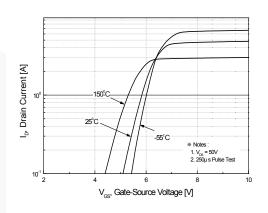


Figure 2. Transfer Characteristics

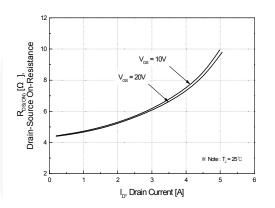


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

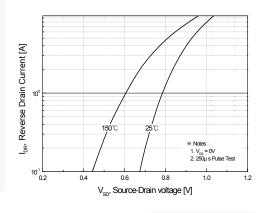


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

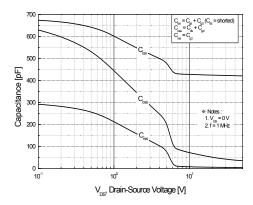


Figure 5. Capacitance Characteristics

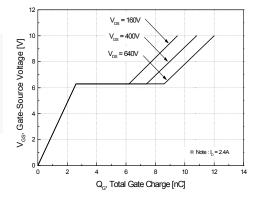
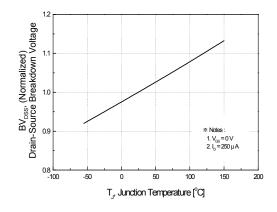


Figure 6. Gate Charge Characteristics

## Typical Characteristics (continued)



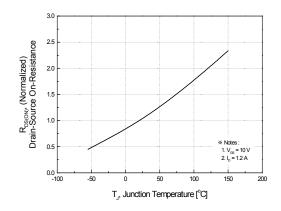
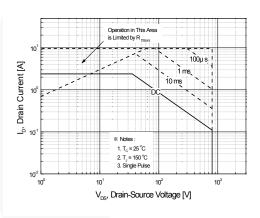


Figure 7. Breakdown Voltage Variation vs Temperature





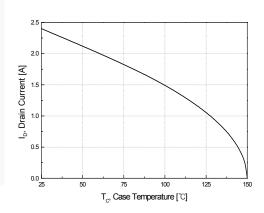


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

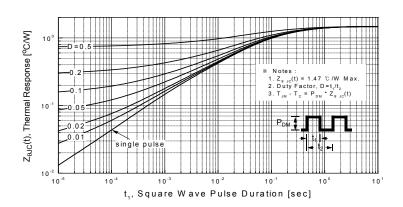


Figure 11. Transient Thermal Response Curve

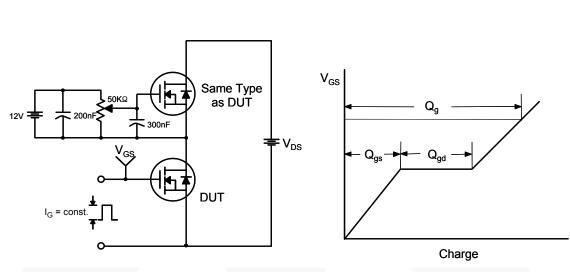


Figure 12. Gate Charge Test Circuit & Waveform

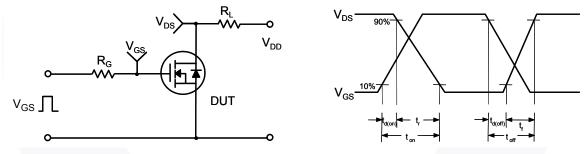


Figure 13. Resistive Switching Test Circuit & Waveforms

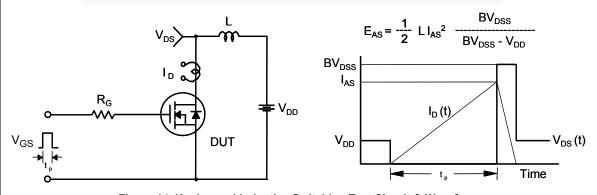
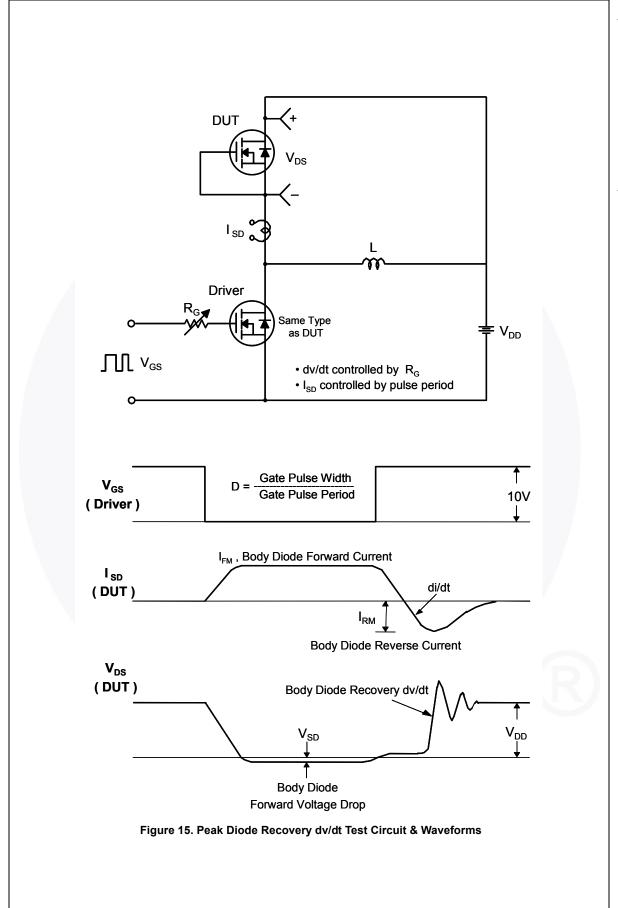


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



## **Mechanical Dimensions**

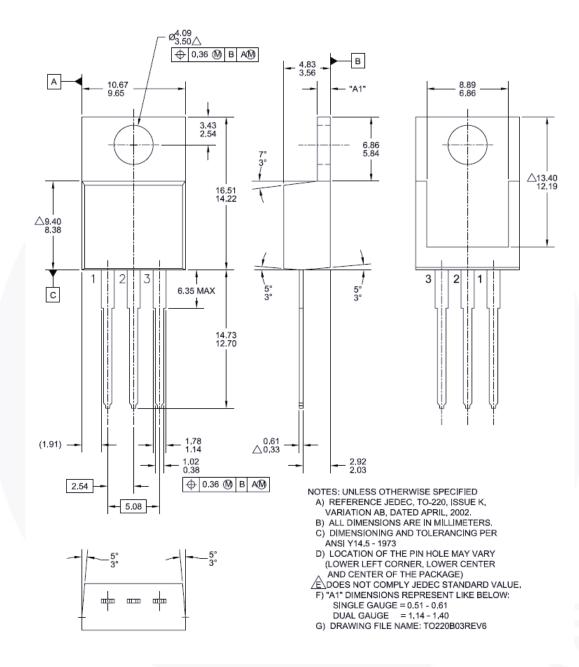


Figure 16 TO-220, Molded, 3-Lead, Jedec Variation AB

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## > Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

## > Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

## Customer Service :

Email service@ameya360.com

## Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com